New Jersey Semi-Conductor Products, Inc.

20 STERN AVE. SPRINGFIELD, NEW JERSEY 07081 U.S.A. TELEPHONE: (973) 376-2922

(212) 227-6005

FAX: (973) 376-8960

IRFP360, IRFP362

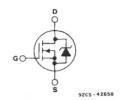
Avalanche-Energy-Rated N-Channel Power MOSFETs

23 A and 20 A, 400 V $r_{\text{DS(on)}}$ = 0.20 Ω and 0.25 Ω

Features:

- Single pulse avalanche energy rated
- SOA is power-dissipation limited
- Nanosecond switching speeds
- Linear transfer characteristics
- High input impedance

N-CHANNEL ENHANCEMENT MODE

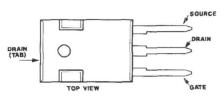


TERMINAL DIAGRAM

The IRFP360 and IRFP362 are advanced power MOSFETs designed, tested, and guaranteed to withstand a specified level of energy in the breakdown avalanche mode of operation. These are n-channel enhancement-mode silicon-gate power field-effect transistors designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high-power bipolar switching transistors requiring high speed and low gate-drive power. These types can be operated directly from integrated circuits.

The IRFP-types are supplied in the JEDEC TO-247 plastic package. $\label{eq:control} % \begin{subarray}{ll} \end{subarray} % \begin{subarray}{ll$

TERMINAL DESIGNATION



JEDEC TO-247

ABSOLUTE MAXIMUM RATINGS

	Parameter	IRFP360	IRFP362	Units
D @ TC = 25°C	Continuous Drain Current	23	20	A
D @ TC = 100°C	Continuous Drain Current	14	13	A
DM	Pulsed Drain Current ①	92	80	A
PD @ T _C = 25°C	Max. Power Dissipation	250		w
	Linear Derating Factor	2	W/°C	
'GS	Gate-to-Source Voltage	±	V	
AS	Single Pulse Avalanche Energy ®	(See F	mJ	
AR	Avalanche Current ®	2	A	
T _J	Operating Junction Storage Temperature Range	-55 t	°C	
	Lead Temperature	300 (0.063 in. (1.6m)	°C	

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

Quality Sami-Conductors

IRFP360, IRFP362

ELECTRICAL CHARACTERISTICS At Case Temperature (T_J) = 25° C Unless Otherwise Specified

	Parameter	Type	Min.	Тур.	Max.	Units	Test	Conditions	
BVDSS	Drain-to-Source Breakdown Voltage	IRFP360 IRFP362	400	-	-	v	V _{GS} = 0V, I _D = 250μA		
R _{DS(on)}	Static Drain-to-Source On-State Resistance ③	IRFP360	_	0.18	0.20	Ω	VGS = 10V, ID = 13A		
		IRFP362	_	0.20	0.25	1 "	-GS - 101, ID - 10A		
^I D(on)	On-State Drain Current ③	IRFP360	23	_	_	A	V _{DS} > I _{D(on)} × R _{DS(on)} Max.		
		IRFP362	20				VGS = 10V		
VGS(th)	Gate Threshold Voltage	ALL	2.0	_	4.0	V	V _{DS} = V _{GS} , I _D = 250μA		
9ts	Forward Transconductance ③	ALL	14	21	-	S(U)	V _{DS} ≥ 50V, I _{DS} = 13A		
IDSS	Zero Gate Voltage Drain Current	ALL	-	_	250	μΑ	VDS = Max. Rating, VGS	- 0V	
			_	-	1000		V _{DS} = 0.8 × Max. Rating.	VGS = 0V, TJ = 125°C	
GSS	Gate-to-Source Leakage Forward	ALL	_	-	500	nA	V _{GS} = 20V		
IGSS	Gate-to-Source Leakage Reverse	ALL	-	-	-500	nA	V _{GS} = -20V		
Q_g	Total Gate Charge	ALL	-	68	100	nC	VGS = 10V, ID = 25A		
Q _{gs}	Gate-to-Source Charge	ALL	_	17	25	nC	V _{DS} = 0.8 × Max. Rating		
Q _{qd}	Gate-to-Drain ("Miller") Charge			24	36	nC	See Fig. 16 (Independent of operating temperature)		
td(on)	Turn-On Delay Time	ALL	_	22	33	ns	$V_{DD} = 200V$, $I_{D} = 25A$, $R_{G} = 4.3\Omega$ $R_{D} = 7.5\Omega$		
t _r	Rise Time	ALL	-	94	140	ns			
td(off)	Turn-Off Delay Time	ALL	_	80	120	ns	See Fig. 15		
t _f	Fall Time	ALL	_	66	99	ns	(Independent of operating to	emperature)	
LD	Internal Drain Inductance	ALL.	-	5.0	-	nH	Measured from the drain lead, 6mm (0.25 in.) from package to center of die.	Modified MOSFET symbol showing the internal inductances.	
LS	Internal Source Inductance	ALL	_	13	-	nH	Measured from the source lead, 6mm (0.25 in.) from package to source bonding pad.		
Ciss	Input Capacitance	ALL	-	4000	-	pF	VGS = 0V, VDS = 25V		
Coss	Output Capacitance	ALL	-	550	_	pF	f = 1.0 MHz		
Cras	Reverse Transfer Capacitance	ALL	_	97	_	pF	See Fig. 10		
Revic	Junction-to-Case	ALL	_	_	0.50	°C/W			
Rincs	Case-to-Sink	ALL	_	0.24	_	°C/W	Mounting surface flat, smooth, and greased		
RINA	Junction-to-Ambient	ALL	_	-	40	°C/W	Typical socket mount		
	Mounting torque	ALL	_	_	10	in.elbs.	Standard 6-32 screw		

Repetitive Rating; Pulse width limited by maximum junction temperature (see figure 5) Refer to current HEXFET reliability report

SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS

Parameter Type		Туре	Min.	Тур.	Max.	Units	Test Conditions	
Is	Continuous Source Current (Body Diode)	ALL	-	-	23	А	Modified MOSFET symbol showing the integral Reverse p-n junction rectifier.	
ISM	Pulsed Source Current (Body Diode) ①	ALL	-	-	92	A		
V _{SD}	Diode Forward Voltage ③	ALL	-	-	1.8	v	T _J = 25°C, I _S = 23A, V _{GS} = 0V	
t _{rr}	Reverse Recovery Time	ALL	200	460	1000	ns	$T_{\rm J} = 25^{\rm o}$ C, $I_{\rm F} = 25$ A, $di/dt = 100$ A/ μ s	
ORR	Reverse Recovery Charge	ALL	3.1	7.1	16	μС		
ton	Forward Turn-On Time	ALL	Intrinsic turn-on time is negligible. Turn-on speed is substantially controlled by Ls. + Lp.					

³ Pulse width ≤ 300 µs; Duty Cycle ≤ 2%

 $[\]textcircled{2} \ \textcircled{@} \ V_{DD} = 50 \text{V}, \ \text{Starting} \ T_J = 25 ^{\circ} \text{C}, \\ \text{L} = 4.0 \text{mH}, \ \text{R}_G = 25 \Omega, \ \text{Peak} \ \text{I}_L = 23 \text{A}$